#### Engineering Conferences International ECI Digital Archives

Functional Glasses: Properties And Applications for Energy and Information

Proceedings

Winter 1-10-2013

#### Surface Interactions on Glass Optics During Fabrication, Post Processing & Laser Operation

Tayyab Suratwala Lawrence Livermore National Laboratory

Follow this and additional works at: http://dc.engconfintl.org/functional\_glasses Part of the <u>Materials Science and Engineering Commons</u>

#### **Recommended** Citation

Tayyab Suratwala, "Surface Interactions on Glass Optics During Fabrication, Post Processing & Laser Operation" in "Functional Glasses: Properties And Applications for Energy and Information", H. Jain, Lehigh Univ.; C. Pantano, The Pennsylvania State Univ.; S. Ito, Tokyo Institute of Technology; K. Bange, Schott Glass (ret.); D. Morse, Corning Eds, ECI Symposium Series, (2013). http://dc.engconfintl.org/functional\_glasses/15

This Conference Proceeding is brought to you for free and open access by the Proceedings at ECI Digital Archives. It has been accepted for inclusion in Functional Glasses: Properties And Applications for Energy and Information by an authorized administrator of ECI Digital Archives. For more information, please contact franco@bepress.com.



# Surface interactions on glass optics during fabrication, post processing & laser operation

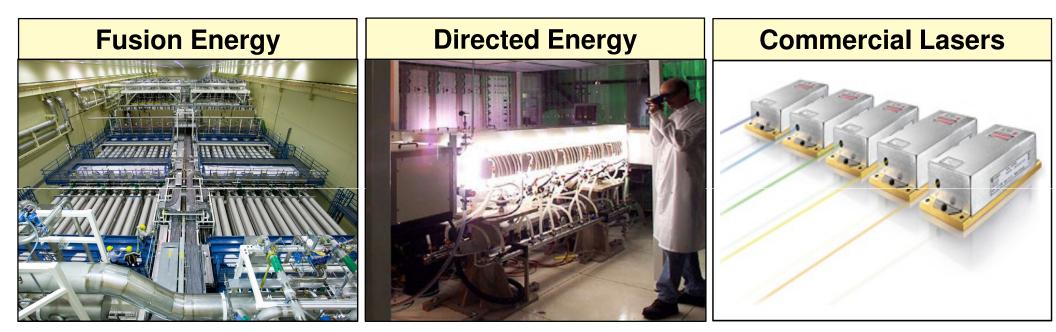
Functional Glasses: Properties and Applications for Energy & Information Siracusa, Sicily, Italy

> Friday, January 11, 2013 Keynote Presentation Tayyab Suratwala

LLNL-PRES-608293-DRAFT

Lawrence Livermore National Laboratory • National Ignition Facility & Photon Science

This work performed under the auspices of the U.S. Department of Energy by Lawrence Livermore National Laboratory under Contract DE-AC52-07NA27344

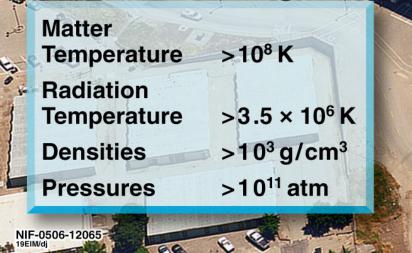


- National Ignition Facility (NIF)
- Mercury Laser
- Laser Inertial Fusion Energy (LIFE)
- Laser MegaJoule (LMJ)
- Laboratory Laser Energetics (LLE)
- Etc....

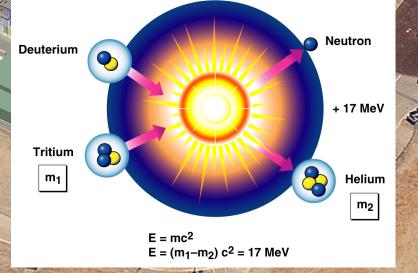
- High-Average-Power Laser (HAPL)
- Diode-pumped, solid-state heatcapacity laser (SSHCL)
- Tailored-aperture ceramic laser (TACL)

NIF concentrates all the energy in a football stadium-sized facility into a mm<sup>3</sup>

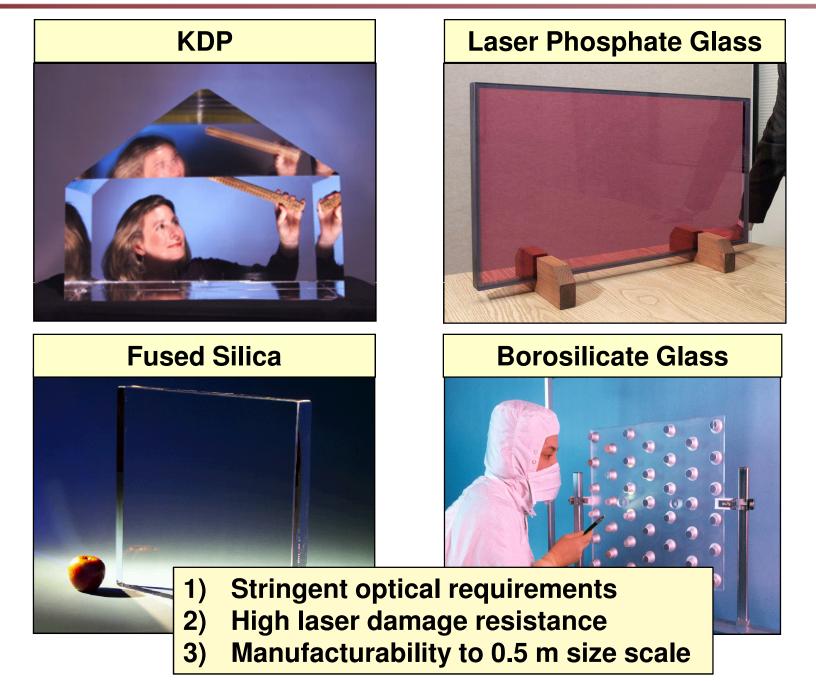
1

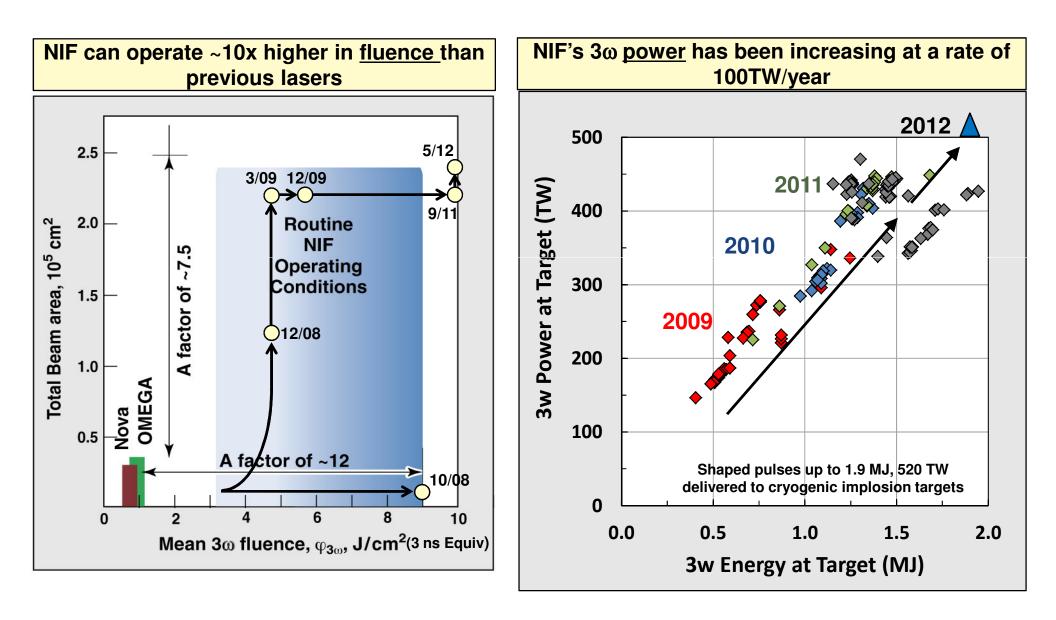


30 335

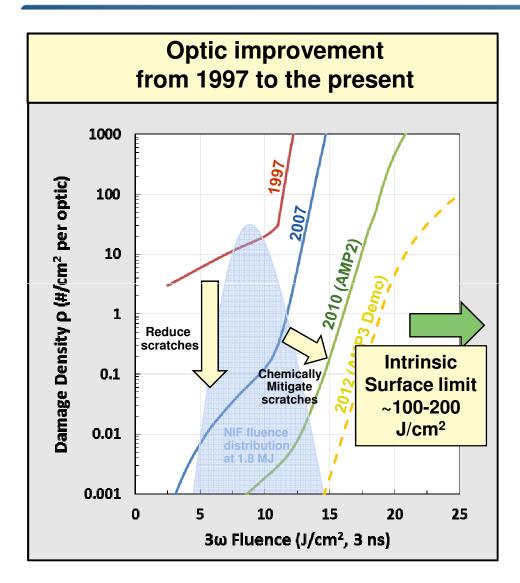


Materials for NIF large optics are limited only to four different glasses or single crystals





Greater understanding glass surface interactions has led to greatly improved high fluence glass optics



- ρ(φ) is the expected density of initiated sites as a function of 3ω illuminating fluence
- ρ(φ) is the metric used to describe the quality of the surface finish
  - Better optics have a lower  $\rho(\phi)$
- Greater than 4 orders of magnitude improvement from 1997 to present
  - Fracture reduction in conventional polishing
  - Chemical treatment to make residual fractures benign

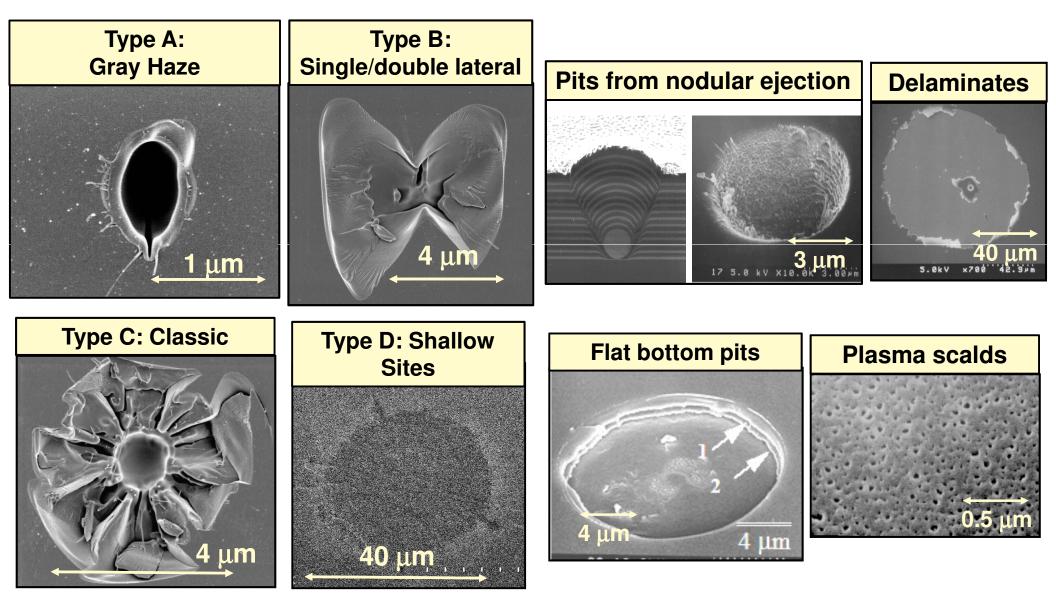
Even today, there is much opportunity to increase surface damage threshold of glass surfaces

### Our S&T has focused on understanding surface interactions on glass surfaces during fabrication, post processing and laser operation

	1. Optical Fabrication	2. Post Processing & Coatings	3. Laser Operation
Current Efforts	<ul> <li>Sub-surface damage management</li> <li>Forensics of surface fractures</li> <li>Fundamentals of material removal</li> <li>Technology of full aperture &amp; small tool optical finishing</li> <li>Low cost, precursor-free finishing techniques</li> </ul>	<ul> <li>Development of chemical/thermal-based flaw/damage mitigation</li> <li>Development of laser-based flaw/damage mitigation</li> <li>Laser interference gratings development</li> </ul>	<ul> <li>Mechanism of initiation &amp; growth (precursors &amp; modulation)</li> <li>Precursor isolation &amp; identification</li> <li>Quantitative understanding initiation &amp; growth behavior</li> <li>Understanding solarization effects</li> <li>Understanding modulation effects</li> </ul>

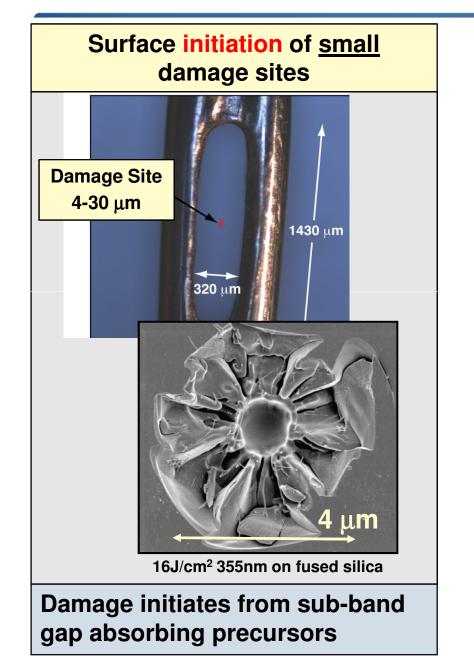
7

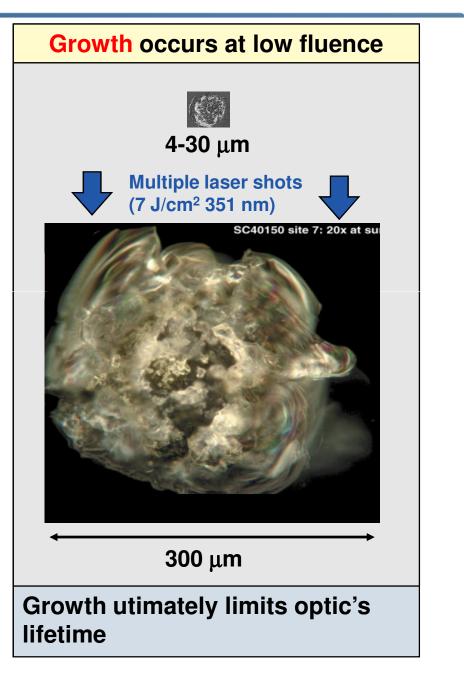
## Various types of microscopic laser damage are observed on high fluence glass optics



W. Carr, SPIE 6403, K1-9 (2007); Génin SPIE 2870, 439-448 (1996);

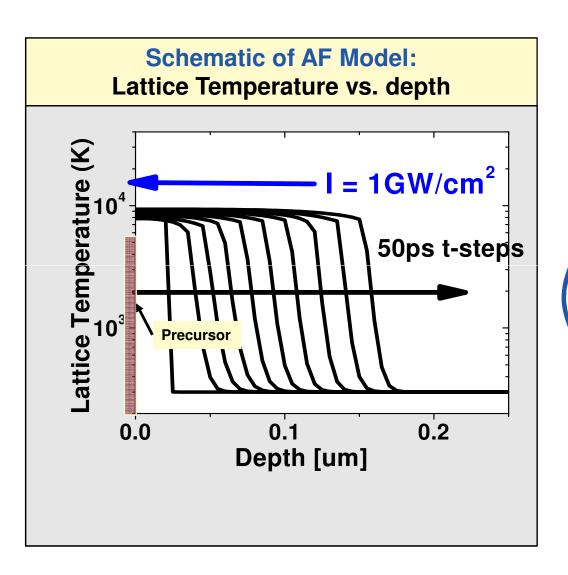
## Many of these damage sites can grow larger with subsequent laser shots





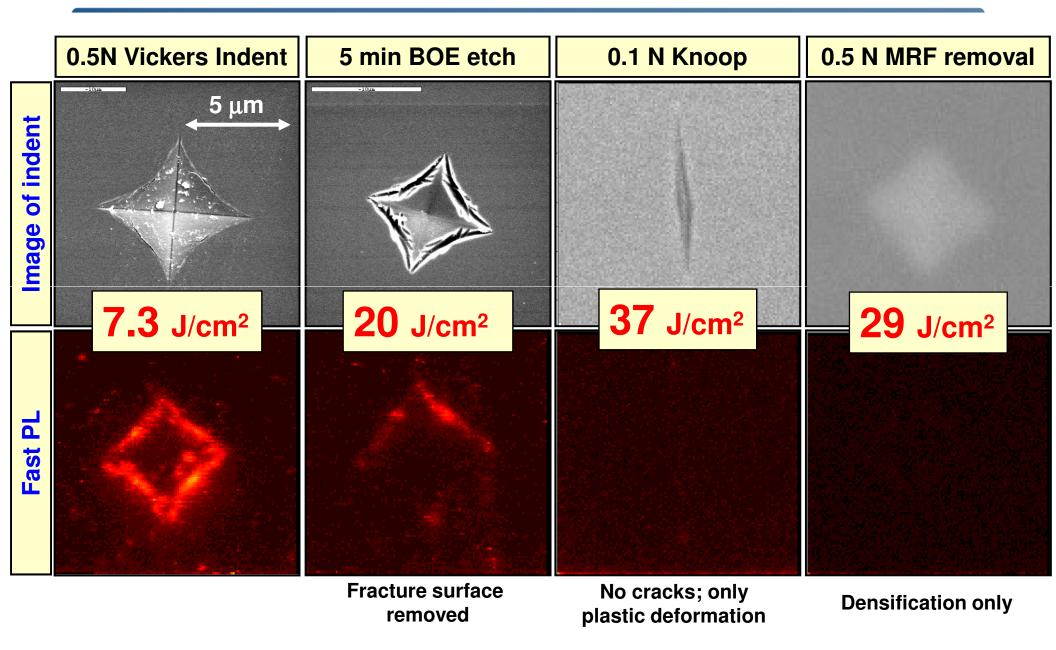
### Laser damage mechanism:

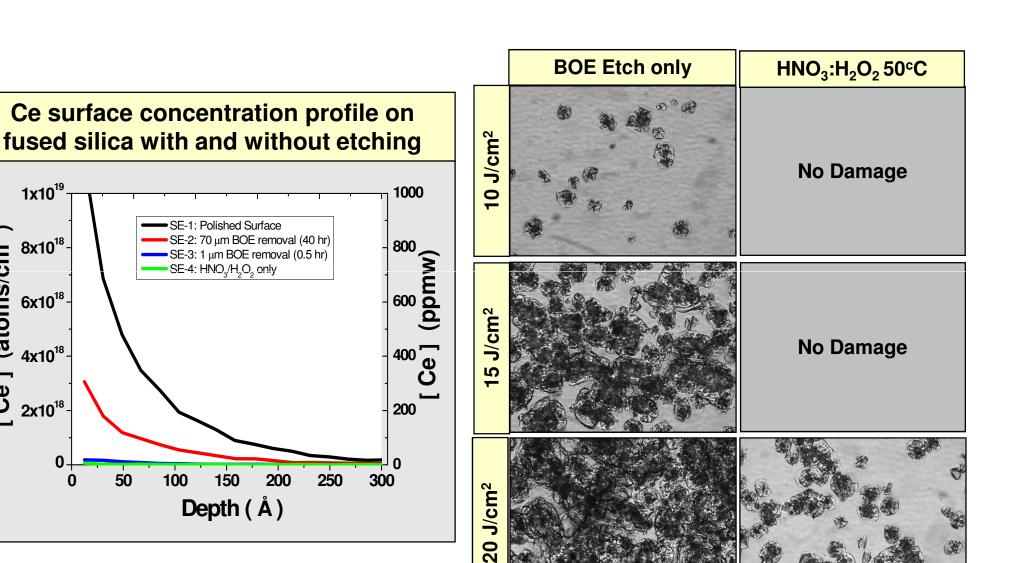
T-activated absorption results in the formation of a laser-driven solid-state absorption front (AF)



- 1. Near surface precursor is heated by absorption of laser light
- 2. T-activated bulk absorption,  $\alpha_{INT}(T)$ : precursor heats the bulk which begins to absorb (thermal runaway)
- 3. T-activated thermal conduction
- 4. Absorption front forms and propagates at velocity v<sub>f</sub>

## Fracture surfaces (not plastic deformation and densification) are low fluence absorbing precursors



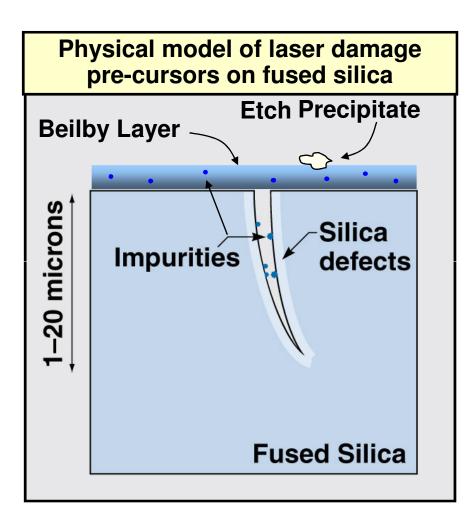


237 µm

#### P. Miller, et. al. US Patent 8,313,662 (11/20/12)

(atoms/cm<sup>3</sup>)

[ Ce ]



1) CHEMICAL IMPURITIES such as Ce in the Beibly layer and in fractures

2) INSTRINSIC SILICA DEFECTS ON FRACTURE SURFACES (e.g. scratches)

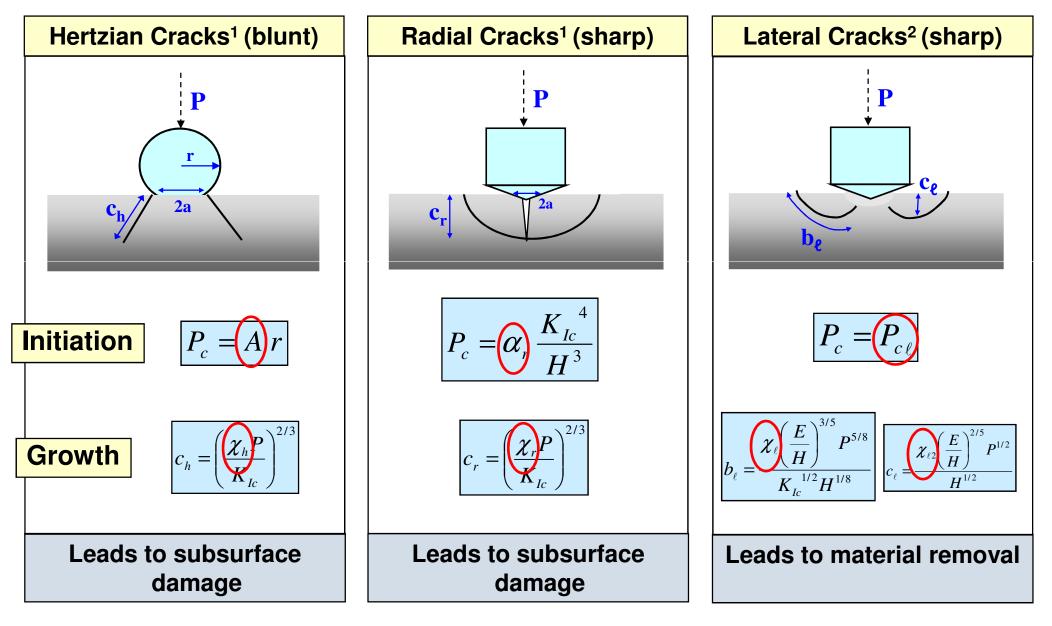
**3) PRECIPITATION PRODUCTS** which can result from subsequent surface treatments (e.g. CO<sub>2</sub> laser, chemical etching)

### Our S&T has focused on understanding surface interactions on glass surfaces during fabrication, post processing and laser operation

1. Optical Fabrication	2. Post Processing & Coatings	3. Laser Operation
<ul> <li>Sub-surface damage management</li> <li>Forensics of surface fractures</li> <li>Fundamentals of material removal</li> <li>Technology of full aperture &amp; small tool optical finishing</li> <li>Low cost, precursor-free finishing techniques</li> </ul>	<ul> <li>Development of chemical/thermal-based flaw/damage mitigation</li> <li>Development of laser-based flaw/damage mitigation</li> <li>Laser interference gratings development</li> </ul>	<ul> <li>Mechanism of initiation &amp; growth (precursors &amp; modulation)</li> <li>Precursor isolation &amp; identification</li> <li>Quantitative understanding initiation &amp; growth behavior</li> <li>Understanding solarization effects</li> <li>Understanding modulation effects</li> <li>Higher fluence precursor identification &amp; mitigation</li> <li>Understand multi-pulse surface &amp; radiation effects</li> <li>Understand/mitigating debris-induced damage</li> <li>Understand damage mechanisms on other glass optics (including coatings)</li> <li>Development of new glass optical materials (e.g., high fluence optical filters)</li> </ul>

Current Efforts

## There are three basic types of cracks created by static brittle indentation

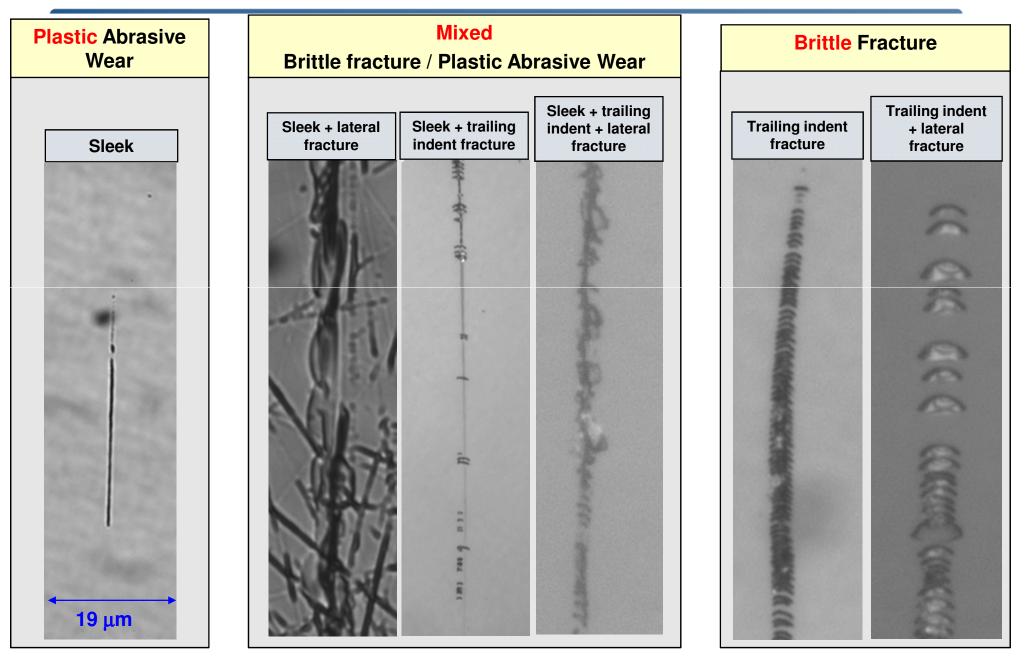


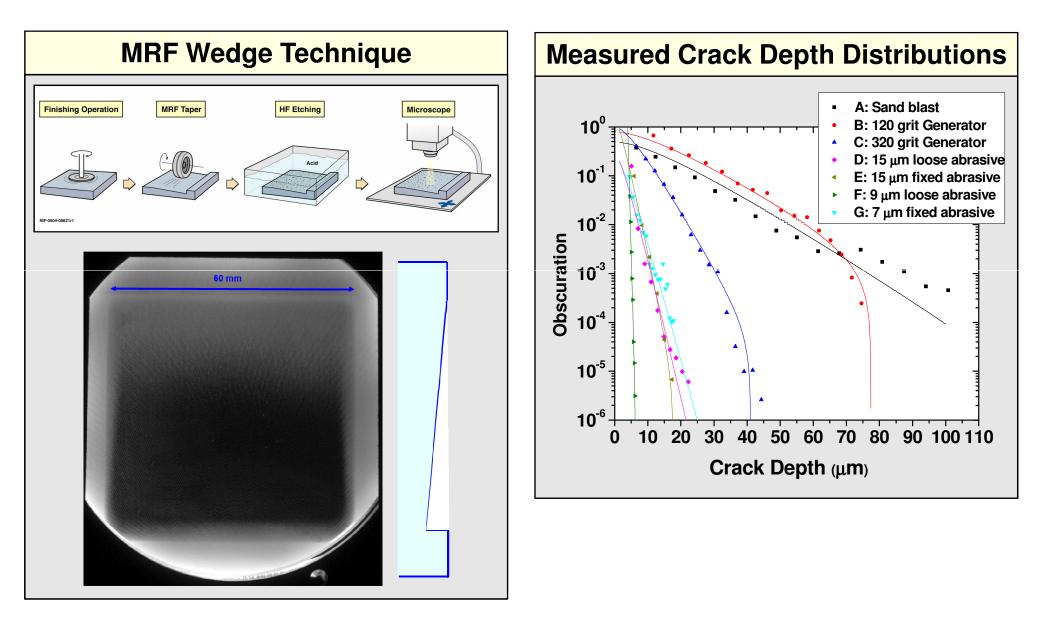
1. B. Lawn, "Fracture of Brittle Materials" (1993)

2. I. Hutchings "Tribology: Friction and Wear of Engineering Materials" (1992)

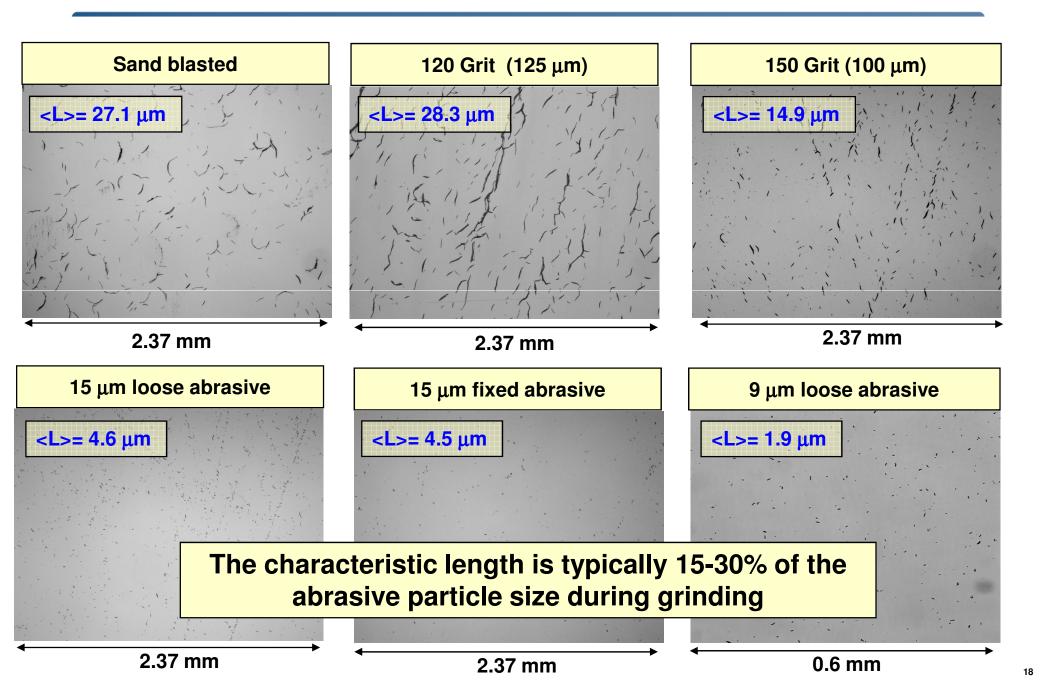
#### NIF

## There are multiple types of scratches which can be divided into three basic categories

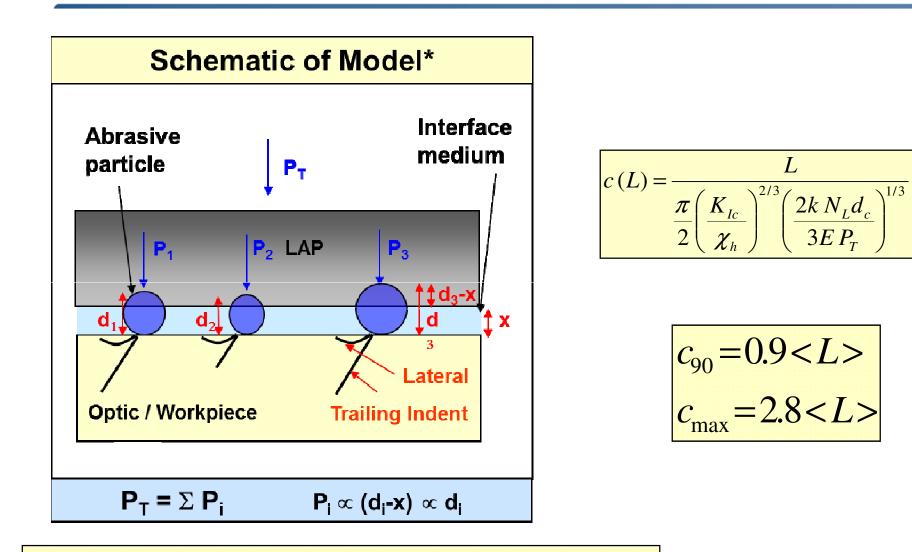




#### Microscope images of the fractures show a unique size character for each grinding step



#### A brittle fracture model has been successfully used to explain the observed distribution of crack depth and lengths



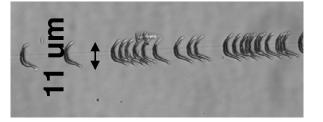
## Key assumption: The load on particle is proportional to its vertical dimension

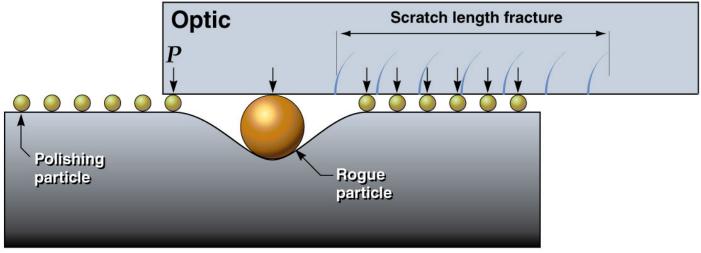
\*T. Suratwala, JNCS 352 (2006) 5601. P. Miller, SPIE 5991 (2005).

NIF

Ω

During polishing large rogue particles or asperities bear high loads leading to sub-surface fractures (scratches)





#### Viscoelastic Lap (Pitch or Pad)

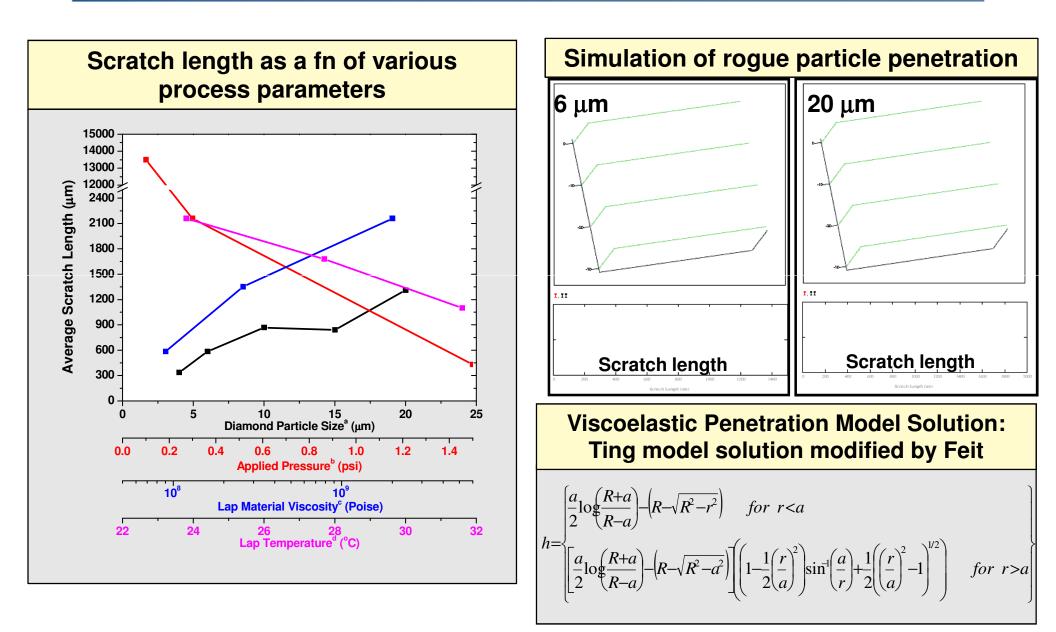
- Particle viscoelastically penetrates into pad
- Time frame of high load exposure determines scratch length

$$L_{scratch} = 8.9 \frac{v_{ave} \eta R^2}{P}$$

The scratch length correlates with viscoelastic model wrt rogue particle size, pressure, lap viscosity, and lap

tt = 0 m sec

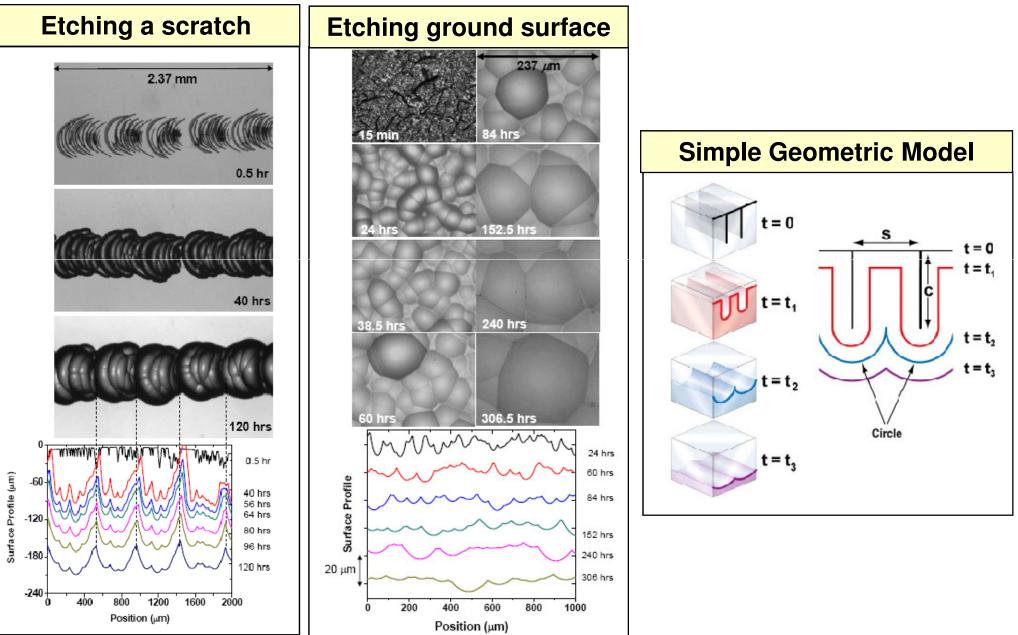
NIE



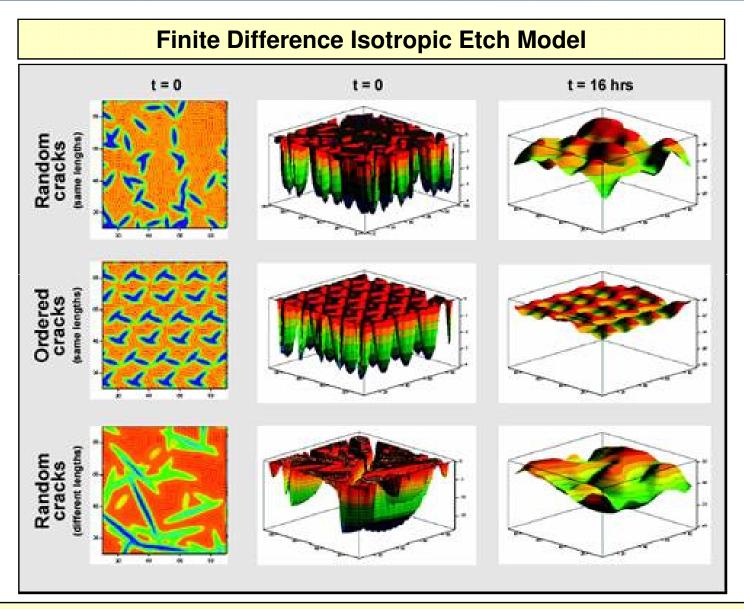
# These studies have provided <u>new</u> rules that Opticians use to diagnose the cause of or to mitigate scratches

Property of scratch	rty of scratch What can it tell you?		Rule / Example			
1. Scratch width or	- Size of rogue particle (d)	For grinding				
trailing indent length (L)	- Size distribution of Rogue Particles	$0.15 d \le L \le 0.3 d$				
	- Process step		For polishing			
	- Depth of fracture (c <sub>90</sub> or c <sub>max</sub> )	0	$0.3 d \le L \le 0.5 d$			
2. Number density	- Rogue particle concentration		Sample	<l></l>		
3. Scratch length (L <sub>scratch</sub> )	- Lap properties and rogue particle size	100	A: Sandblast	27.1 μm		
4. Scratch type (plastic,	- Load during fracture		B: 120 grit	28.3 μm		
Brittle, mixed)	- Sharpness of particle		C: 320 grit	14.9 μm		
5. Orientation and	- Particle movement direction		D: 15 µm loose	4.6 µm		
Pattern of trailing indent	- Particle rotation		E: 15 µm fixed	<b>4.5 μm</b>		
	- Stick slip behavior		F: 9 μm loose	1.9 μm		
6. Curvature	- Pathway of indenting particle		G: 7 µm fixed	<mark>8.4 μm</mark>		
or scratch pattern	- Shape of tool	90 =	$=0.9 < L > c_{\rm m}$	<sub>ax</sub> =2.8<	$\langle L \rangle$	
	- Handling vs polishing $P \approx$	: 0.	001 - 0.1 N	Plastic o	only	
7. Location on optic	- Material removal & figure $P \approx$	: 0.	1-5 N Plas	stic & B	Rrittle	
	P >	51	V Pla	stic & r	ubble	
		L	$s_{scratch} = 8.9^{-1}$	$\gamma_{ave}^{}\eta R^{2}$		

# HF etching can be used after grinding to remove subsurface fracture because it annihilates neighboring cracks

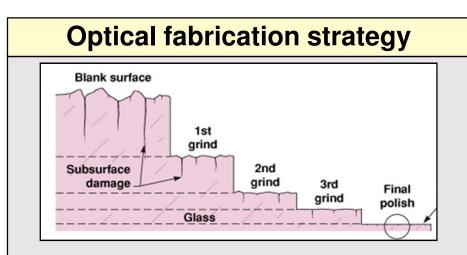


# A finite difference etching model has been developed to determine optimum etching times and key process variables

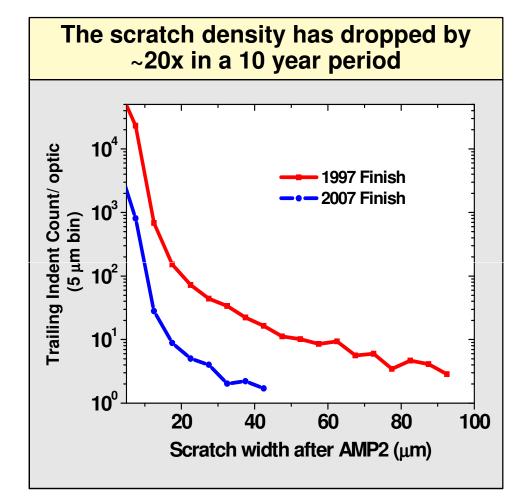


Crack distribution strongly affects etching time needed for crack annihilation

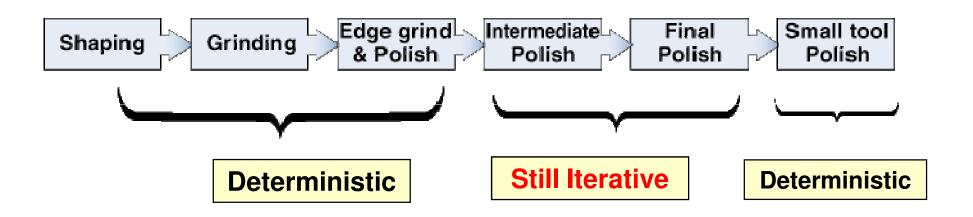
#### Science & Technology based optical fabrication strategy was implemented to greatly reduced scratch densities



- 1. Measure the subsurface damage (SSD)
- 2. Define proper removal
- 3. Use etching to remove SSD after grinding
- 4. Ensure handling & cleaning prevents rogue particle contact
- 5. Remove rogue particles in polishers
- 6. Use etched scratch inspections
- 7. Use scratch forensics to identify & mitigate source of scratches

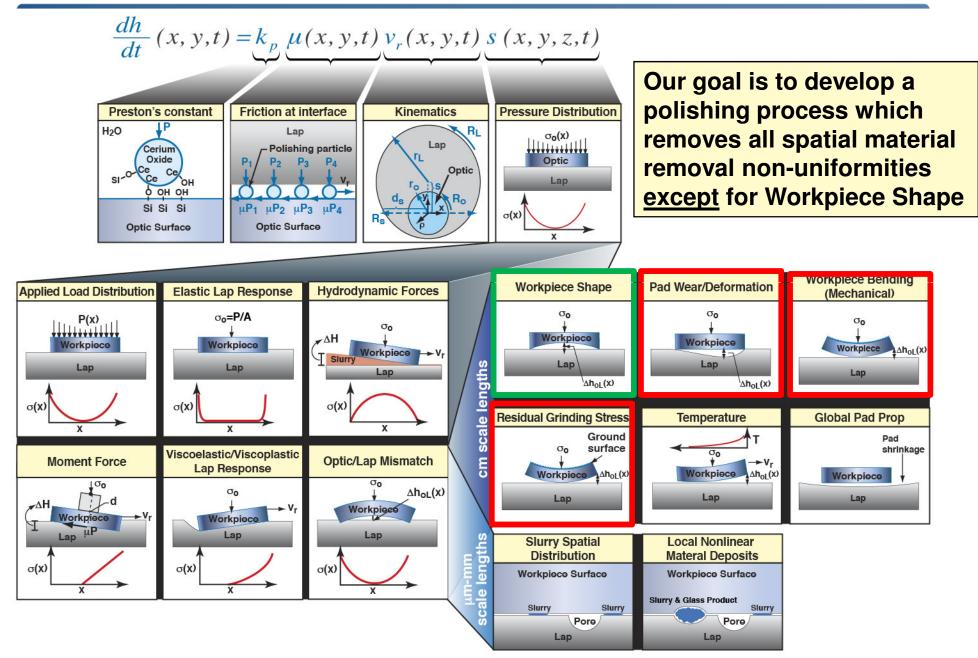


Trailing indent = individual fractures in a scratch

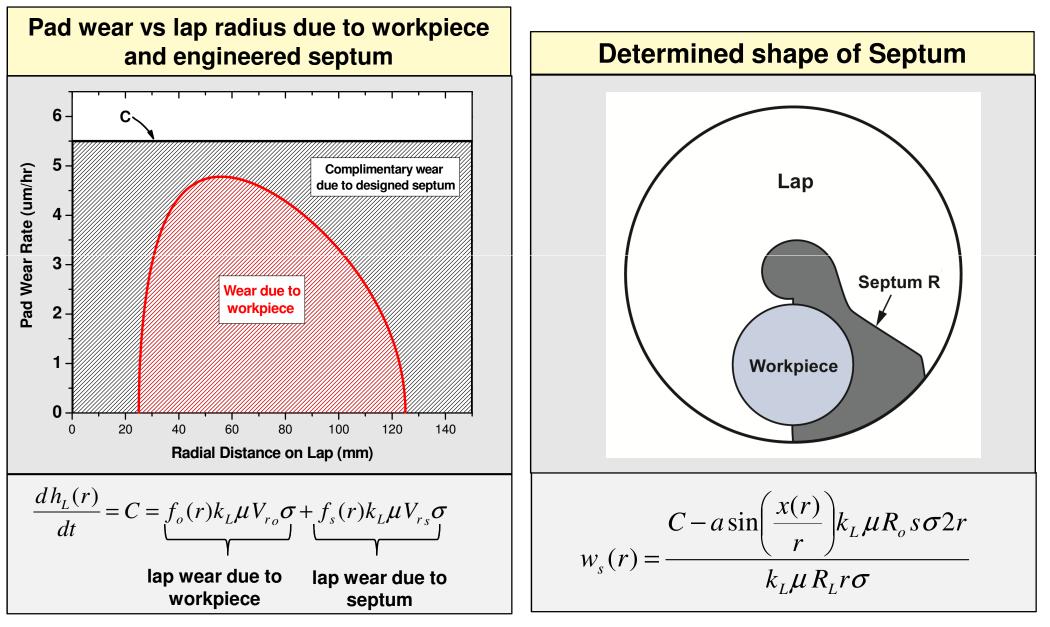


- Involves multiple polishing and metrology iterations
- Time consuming and labor intensive
- Figure not corrected here is performed by small tool

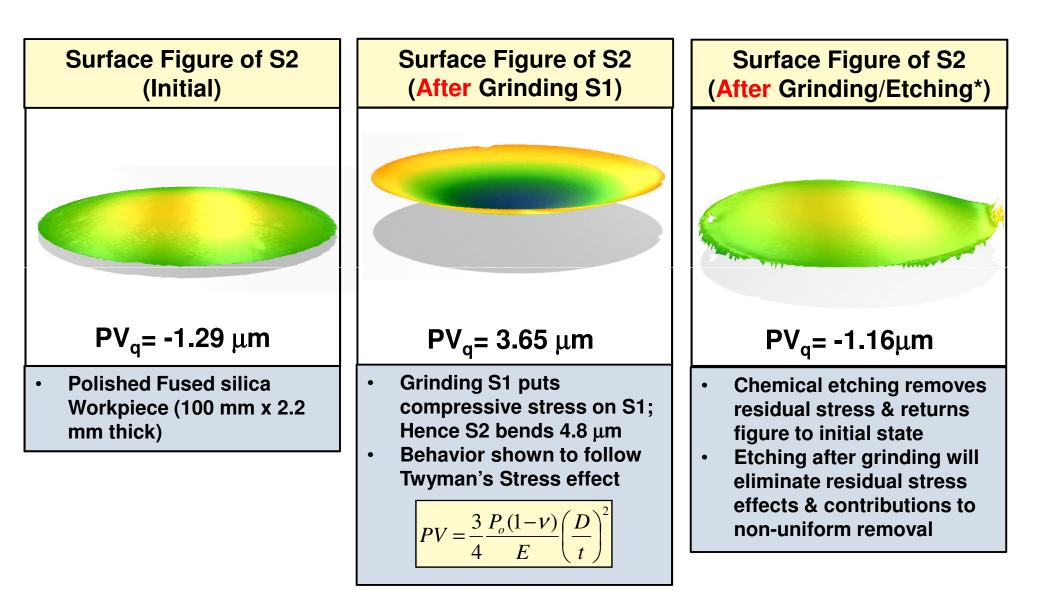
### Systematic effort to understand all the phenomena that affect material removal has been conducted



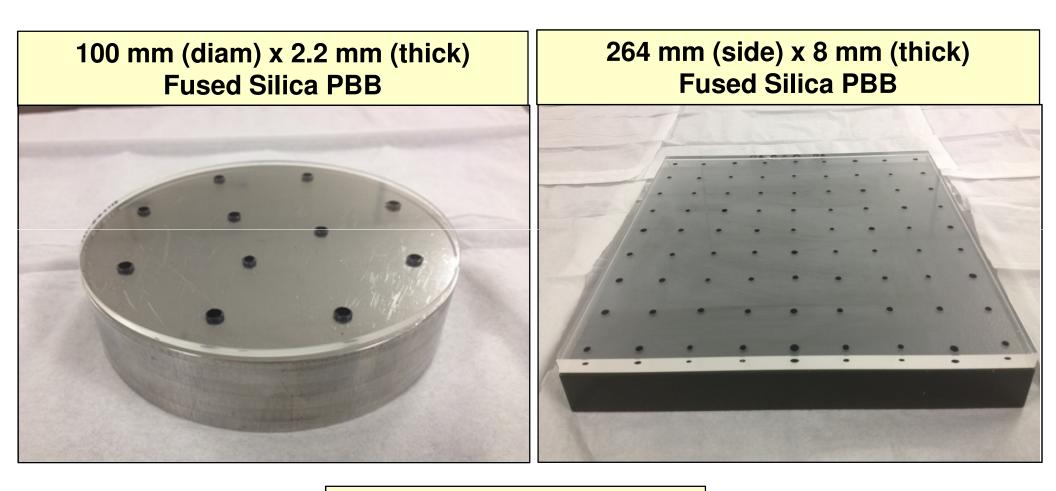
### A novel septum has been designed to counteract non-uniform wear on the pad



T. Suratwala, US Provisional Patent Application 61454893 (Mar 2011)

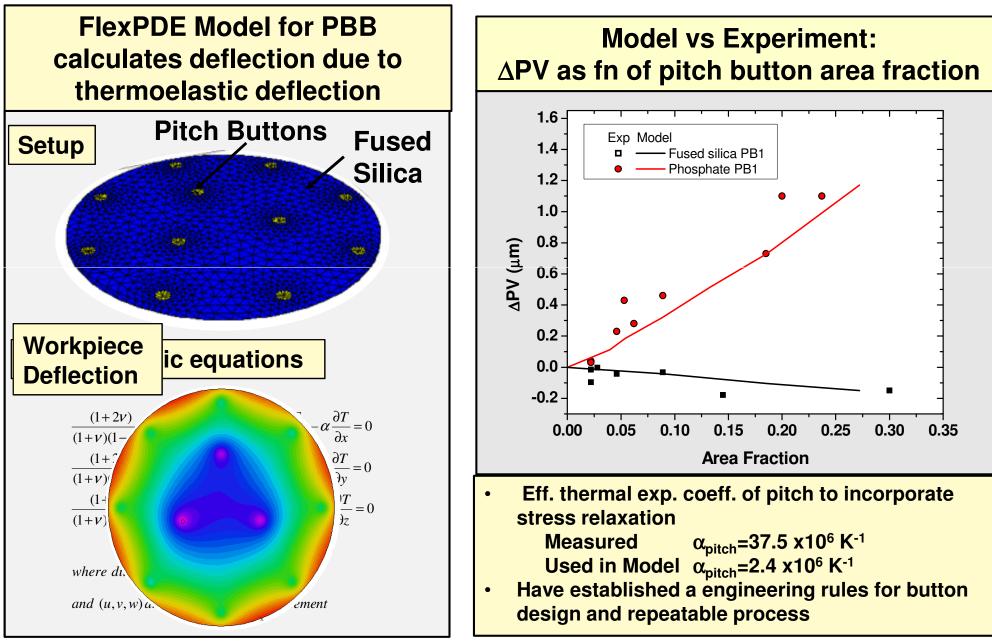


# New Pitch Button Blocking (PBB) process provides low deflections for fused silica and phosphate glass



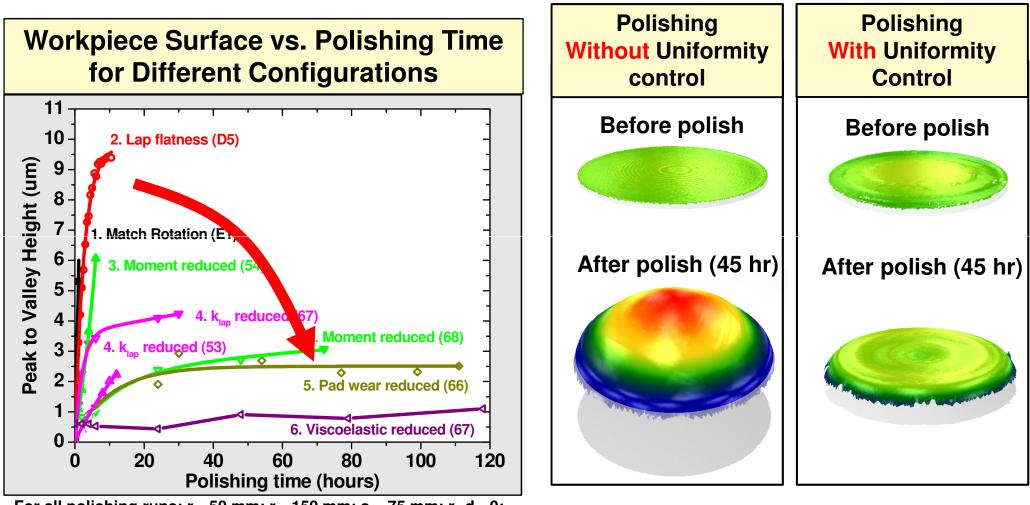
FS $\Delta$ PV=0.003 μmPhosphate $\Delta$ PV=0.035 μm

# A thermo-elastic model, with stress relaxation of pitch, can explain PBB behavior



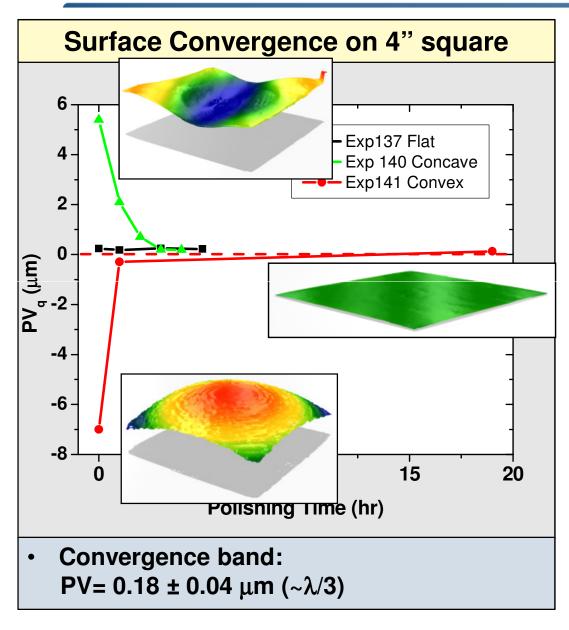
M. Feit, Applied Optics (Dec. 2012)

# The major sources of non-uniform spatial removal been identified and mitigated



For all polishing runs:  $r_0=50 \text{ mm}$ ;  $r_L=150 \text{ mm}$ ; s = 75 mm;  $r_s,d_s=0$ ;  $P_A=0.3 \text{ psi}$ 

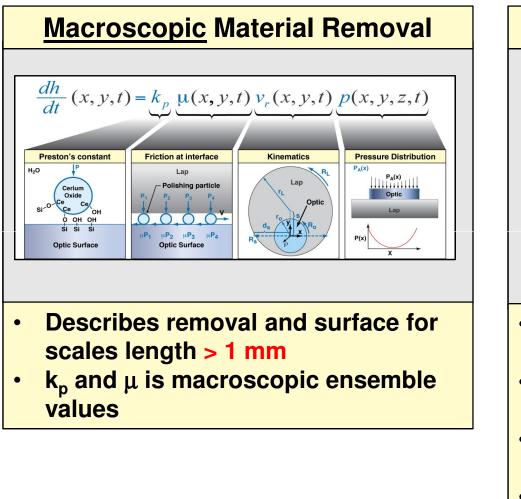
### New <u>Convergent Polishing</u> has been demonstrated on 4"-10" round & square plano glass optics

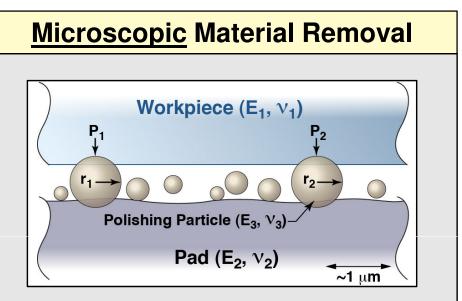


T. Suratwala, IJAGS 3(1) 14-28 (2012) T. Suratwala , US Patent Application 61454893 (Mar 2011)



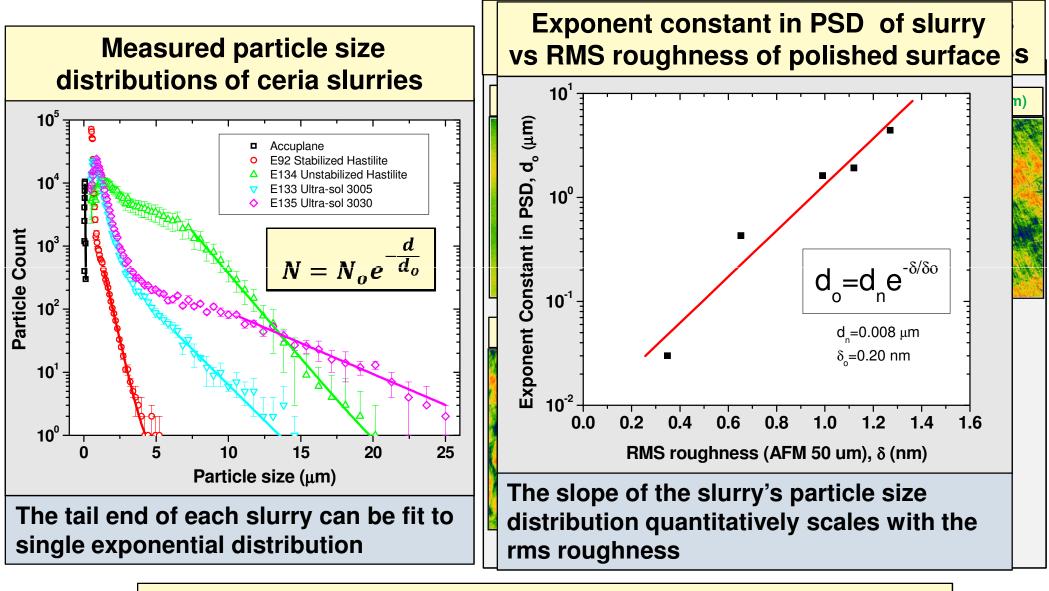
# The Preston model has been extended to the <u>microscopic</u> scale to describe smaller spatial scale length effects



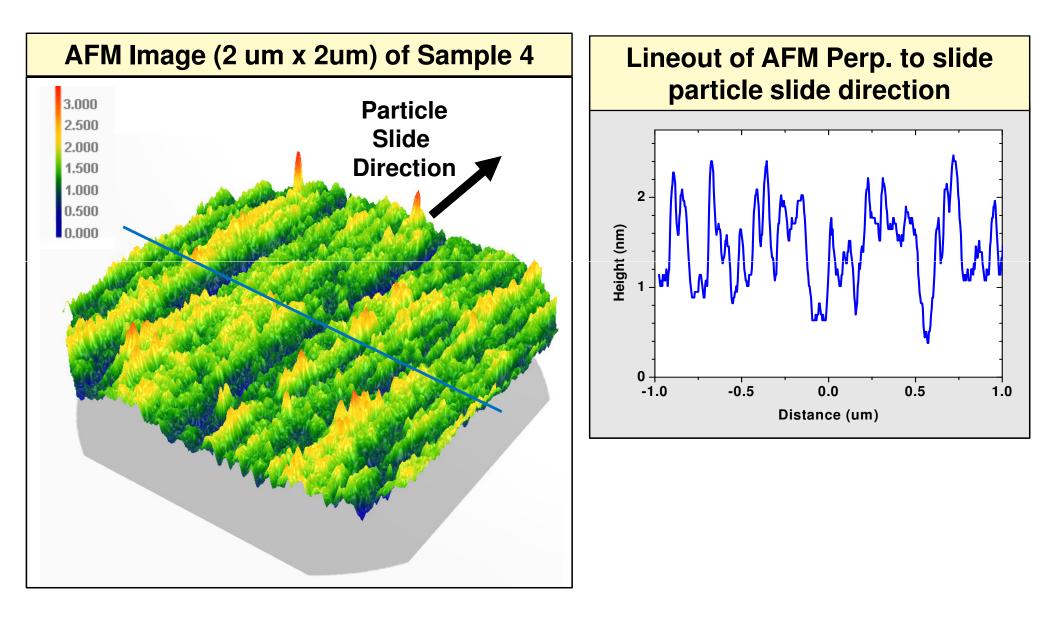


- Describes removal and surface for scales lengths nm to mm
- Hertzian contact zone determines removal area
- Lap topology and particle size dist determine number of contacts
- Ensemble determines macroscopic value of  $\textbf{k}_{p}$  and  $\mu$

## The slurry's tail end of the distribution strongly correlates with workpiece roughness



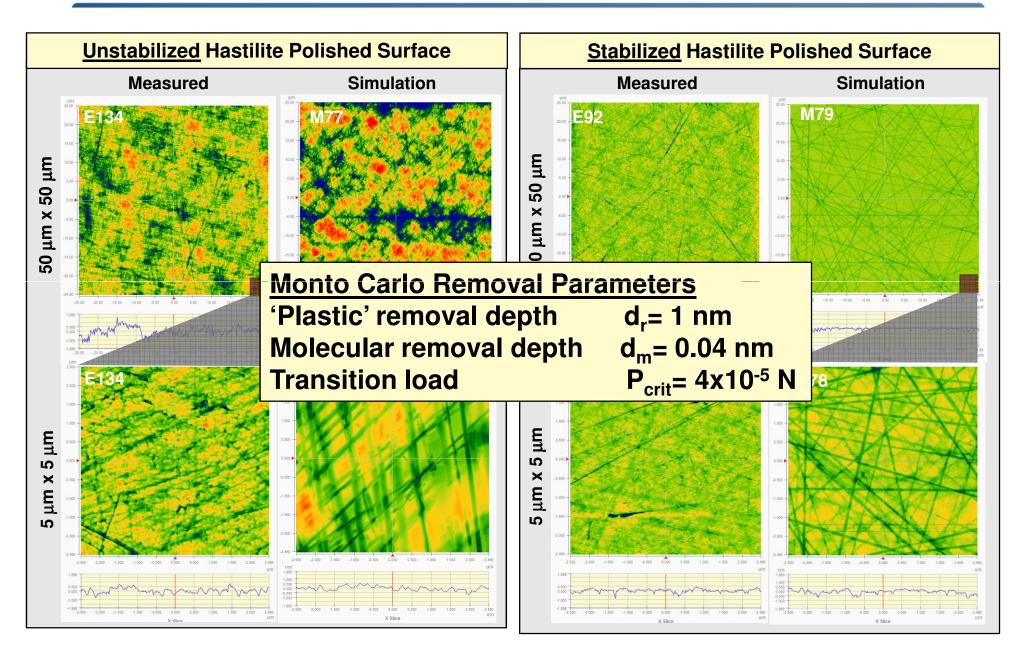
Stresses the need to get slurry PSD with small  $d_o$  to get low roughness surface; Mean particle size is not as important!



Using a single set of parameters, polished surfaces have been simulated over multiple spatial scale lengths using different slurry particle size distributions

11/23/12

NIF

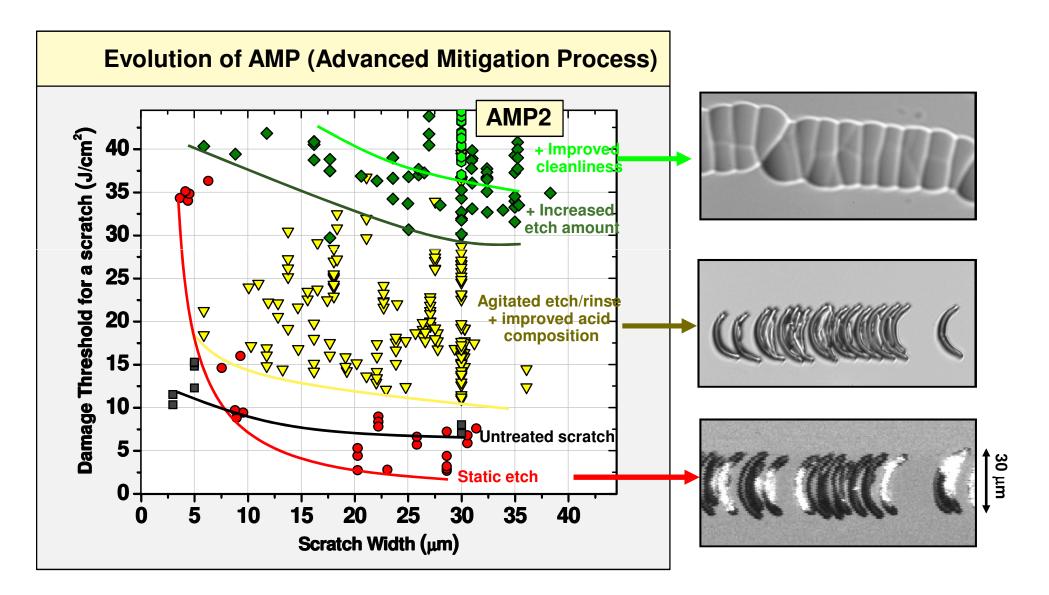


M76-79 Zernikes removed Only

#### Our S&T has focused on understanding surface interactions on glass surfaces during fabrication, post processing a

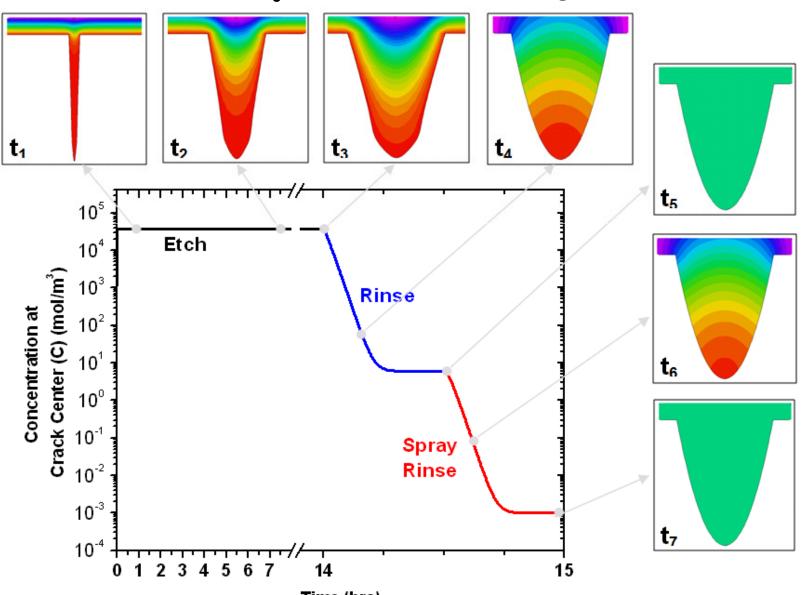
processing and laser operation					
1. Optical Fabrication	2. Post Processing & Coatings	3. Laser Operation			
<ul> <li>Sub-surface damage management</li> <li>Forensics of surface fractures</li> <li>Fundamentals of material removal</li> <li>Technology of full aperture &amp; small tool optical finishing</li> <li>Low cost, precursor-free finishing techniques</li> </ul>	<ul> <li>Development of chemical/thermal-based flaw/damage mitigation</li> <li>Development of laser-based flaw/damage mitigation</li> <li>Laser interference gratings development</li> </ul>	<ul> <li>Mechanism of initiation &amp; growth (precursors &amp; modulation)</li> <li>Precursor isolation &amp; identification</li> <li>Quantitative understanding initiation &amp; growth behavior</li> <li>Understanding solarization effects</li> <li>Understanding modulation effects</li> </ul>			
<ul> <li>Toward deterministic finishing (away from artisan, iterative finishing)</li> <li>Science of finishing continued (microscopic, molecular, &amp; chemical interactions)</li> <li>Development of new finishing techniques</li> </ul>		<ul> <li>Higher fluence precursor identification &amp; mitigation</li> <li>Understand multi-pulse surface &amp; radiation effects</li> <li>Understand/mitigating debris- induced damage</li> <li>Understand damage mechanisms on other glass optics (including coatings)</li> <li>Development of new glass optical materials (e.g., high fluence optical filters)</li> </ul>			

# Optimization of etching processes have led to large increases in the damage resistance of scratches



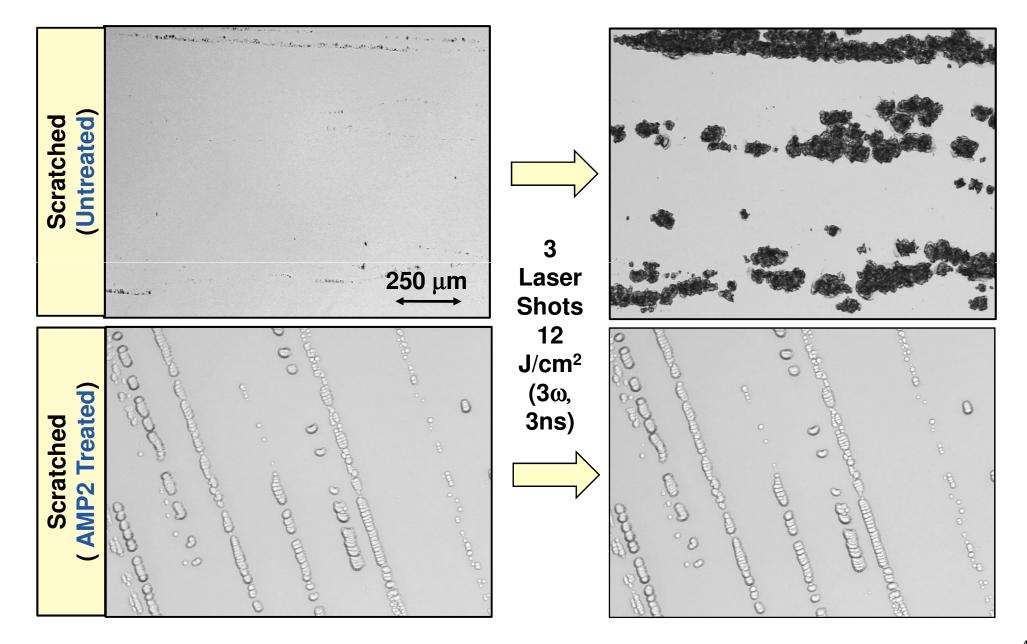
T. Suratwala, et. al. J. Am. Cer. Soc. 94 (2) (2010) 416-428; P. Miller, et. al. US Patent 8,313,662 (11/20/12)

Using a mass transport model, process has been optimized to minimize reaction product concentration left in the crack

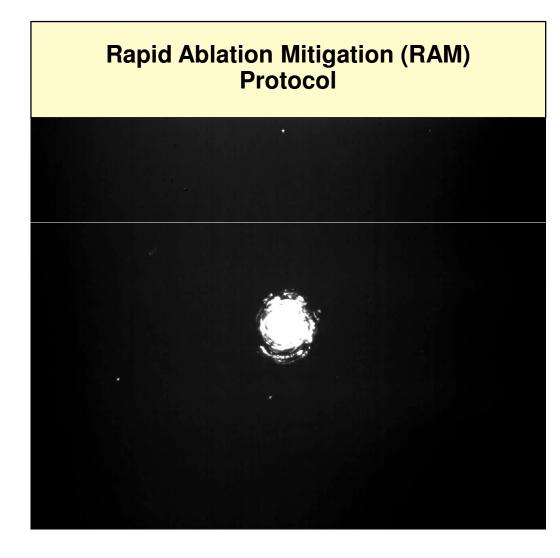




# Using AMP2, scratches as a damage precursor in NIF have been eliminated



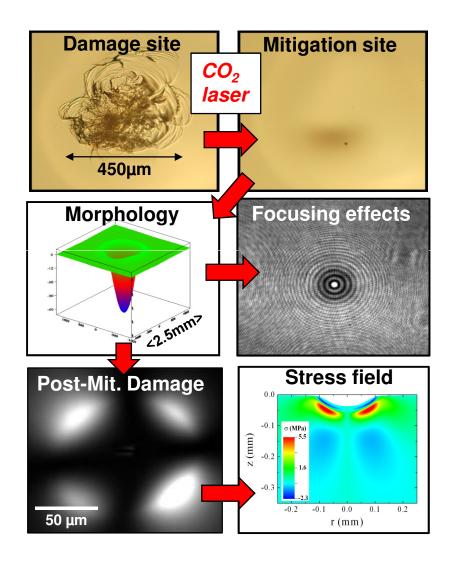




- Utilizes rapid scanning of tightlyfocused high-power CO<sub>2</sub> laser pulses to remove flaws up to ~0.5 mm diameter
  - Precise shape control
  - Fairly wide process margin
  - Scalable
  - Damage robust
- The cone is the only shape identified that does not lead to downstream intensification



RAM "cone" protocol on fused silica Successful optics damage mitigation can only be achieved through careful balance of coupled, sometimes competing effects



### <u>UV damage threshold</u>

- Remove or re-flow damaged material
- Free of damage-prone re-deposit

### Light propagation

 Resulting morphology that does not intensify/focus UV light

### **Residual stress & densification**

- Stress below critical fracture limit
- Minimally-extended densification

#### Our S&T has focused on understanding surface interactions on glass surfaces during fabrication, post processing and laser operation

	1. Optical Fabrication	2. Post Processing & Coatings	3. Laser Operation
<b>Current Efforts</b>	<ul> <li>Sub-surface damage management</li> <li>Forensics of surface fractures</li> <li>Fundamentals of material removal</li> <li>Technology of full aperture &amp; small tool optical finishing</li> <li>Low cost, precursor-free finishing techniques</li> </ul>	<ul> <li>Development of chemical/thermal-based flaw/damage mitigation</li> <li>Development of laser-based flaw/damage mitigation</li> <li>Laser interference gratings development</li> </ul>	<ul> <li>Mechanism of initiation &amp; growth (precursors &amp; modulation)</li> <li>Precursor isolation &amp; identification</li> <li>Quantitative understanding initiation &amp; growth behavior</li> <li>Understanding solarization effects</li> <li>Understanding modulation</li> </ul>
<b>Future Challenges</b>	<ul> <li>Toward deterministic finishing (away from artisan, iterative finishing)</li> <li>Science of finishing continued (microscopic, molecular, &amp; chemical interactions)</li> <li>Development of new finishing techniques</li> </ul>	<ul> <li>Development of new chemical &amp; laser mitigations strategies (e.g., for high fluence precursors, damage sites, conditioning)</li> <li>Development of higher fluence multi-layer dielectric coatings</li> <li>Development of stable, high fluence AR coatings</li> </ul>	<ul> <li>effects</li> <li>Higher fluence precursor identification &amp; mitigation</li> <li>Understand multi-pulse surface &amp; radiation effects</li> <li>Understand/mitigating debris- induced damage</li> <li>Understand damage mechanisms on other glass optics (including coatings)</li> <li>Development of new glass optical materials (e.g., high fluence optical filters)</li> </ul>

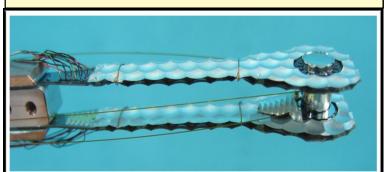
# The optics S&T effort is a multi-disciplinary, multi-team effort

PLS	NIF	ENG
<ul> <li>D. Aberg</li> <li>S. Baxamusa</li> <li>M. Monticelli</li> <li>J. Bude</li> <li>R. Negres</li> <li>S. Demos</li> <li>R. Qiu</li> <li>R. Dylla Spears</li> <li>R. Raman</li> <li>P. Ehrmann</li> <li>B. Sadigh</li> <li>P. Erhart</li> <li>K. Schaffers</li> <li>S. Elhadj</li> <li>E. Schwegler</li> <li>J. Fair</li> <li>R. Steele</li> <li>G. Gilmer</li> <li>C. Stolz</li> <li>T. Laurence</li> <li>T. Suratwala</li> <li>M. Johnson</li> <li>L. Wong</li> <li>M. Matthews</li> <li>J. Wolfe</li> <li>J. Menapace</li> </ul>	<ul> <li>J. Adams</li> <li>I. Bass</li> <li>W. Carr</li> <li>D. Cross</li> <li>R. Desjardin</li> <li>M. Feit</li> <li>G. Guss</li> <li>Z. Liao</li> <li>K. Manes</li> <li>M. Norton</li> <li>M. Norton</li> <li>M. Nostrand</li> <li>M. Spaeth</li> <li>T. Weiland &amp; the OSL Team</li> <li>P. Wegner</li> <li>C. Widmayer</li> <li>S. Yang</li> </ul>	<ul> <li>R. Vignes</li> <li>J. Stolken</li> </ul>

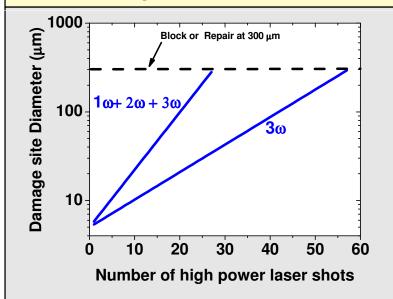
- + Production Facilities (Optic Mitigation Factory, Optics Processing Lab)
- + Engineering Group (Design & Fabrication)
- + Metrology and Coordination Group

# S&T effort also will focus on developing new high fluence optical filters

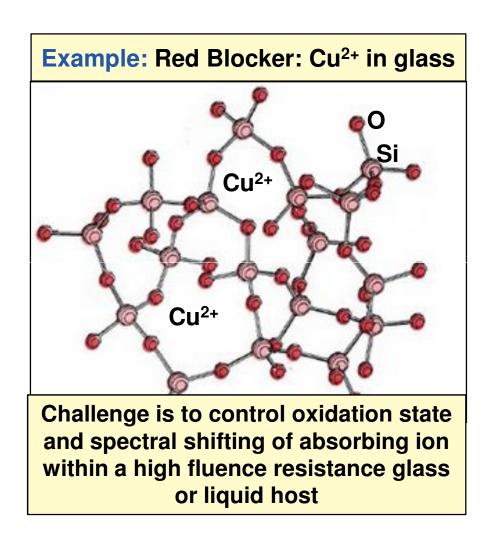
#### Target Performance



**Optic Lifetime** 



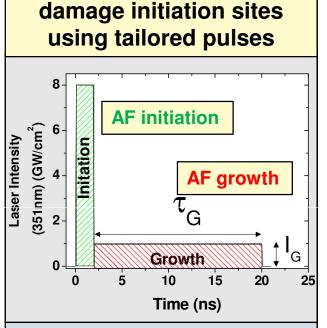
Unconverted laser light degrades target performance and optic lifetime



NIC

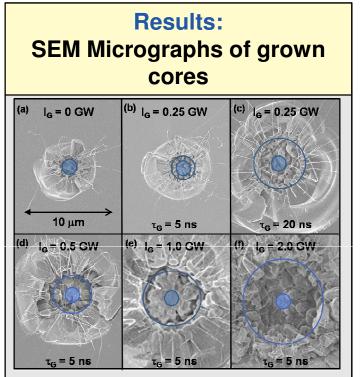
Collaboration with D. Brow; U. of Missouri 49

The AF model has also been validated on actual damage sites using tailored laser pulses and comparing to the measured damage core size

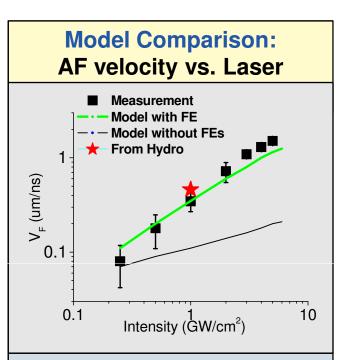


**Experiment: Create** 

- Initiation pulse creates reproducible 2 μm damage sites
- Growth pulse drives AF, creates larger molten cores

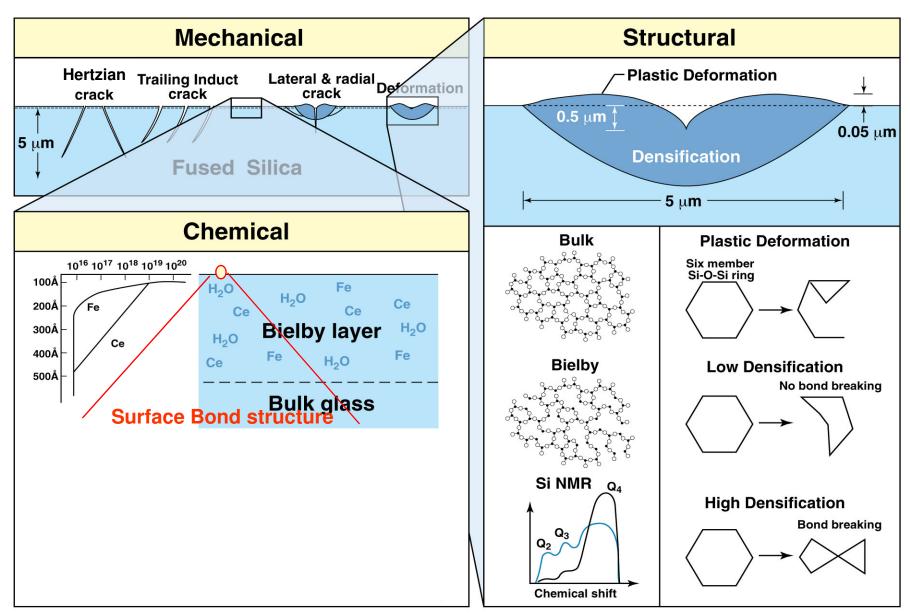


- Outer blue circle indicates the core size for varying growth pulses
- AF velocity determined from change in core size

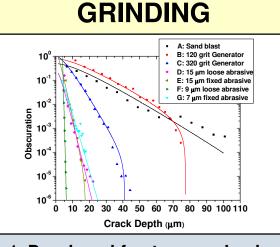


- Modeled V<sub>F</sub> from full 1D energy transport sim. and 3D hydro sim.
- Gives key insight into the damage process and the properties of silica under extreme conditions

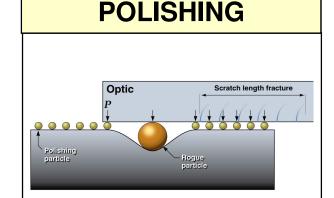
#### There are numerous mechanical, structural and chemical effect on the glass surface during grinding and polishing



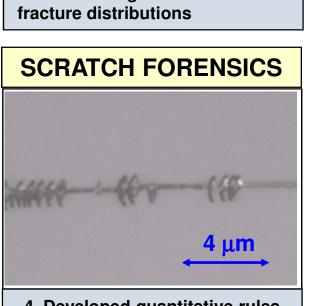
### There are five major areas of effort that have aided in managing sub-surface fractures



1. Developed fracture mechanics understanding of sub-surface fracture distributions

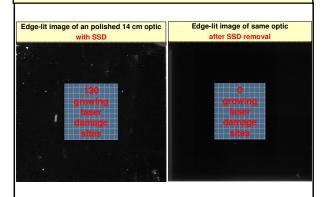


2. Identified/characterized behavior of rogue particles causing sub-surface fractures

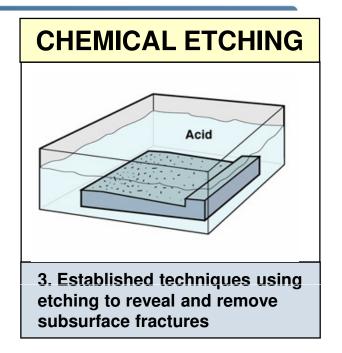


4. Developed quantitative rules for post-diagnosis of cause of surface fractures

#### LASER DAMAGE



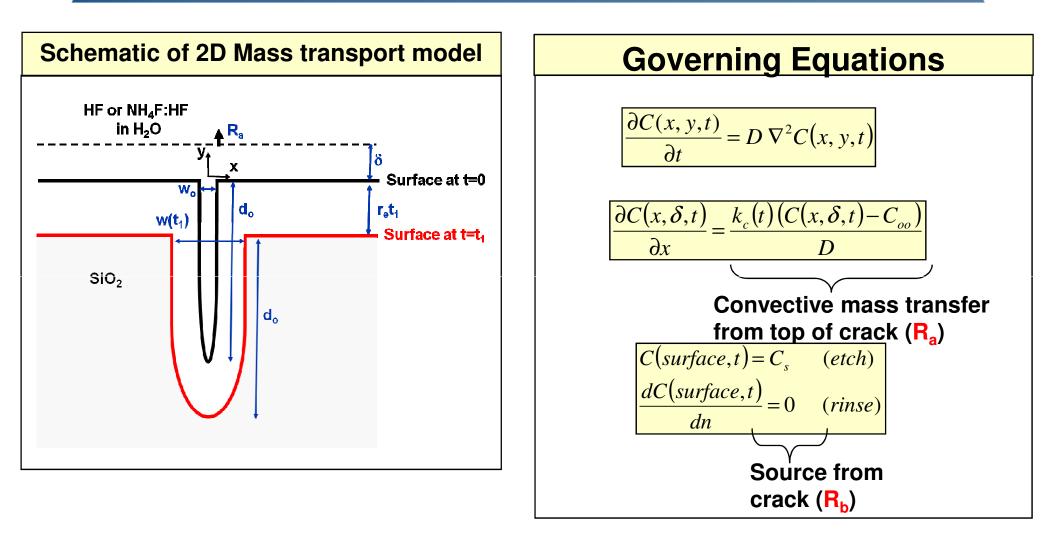
5. Showed link between subsurface fracture removal & improved laser resistance



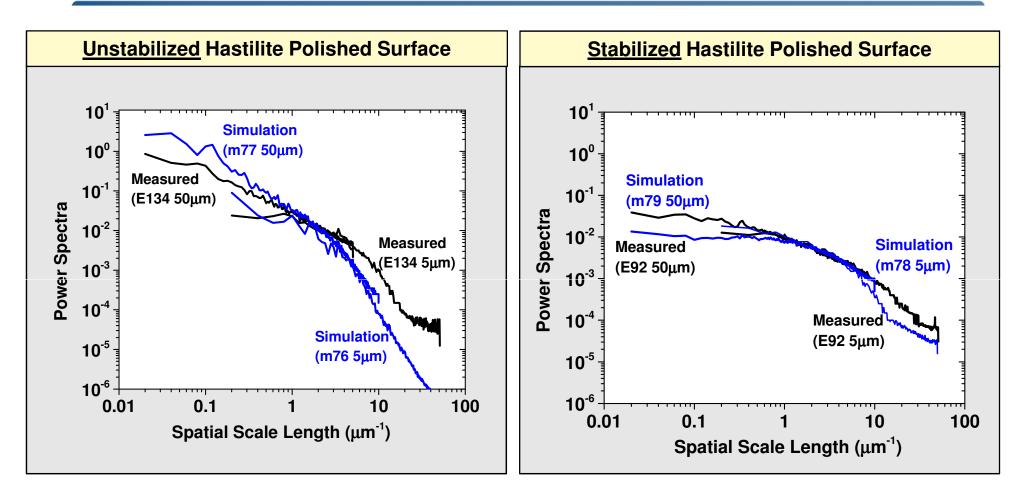
NIF

All of the above have been used to optimize vendor processes to manage sub-surface fractures and to minimize impact of rogue particles

## 2D mass transport model for SiF<sub>6</sub><sup>2-</sup> out of a crack during AMP process has been developed



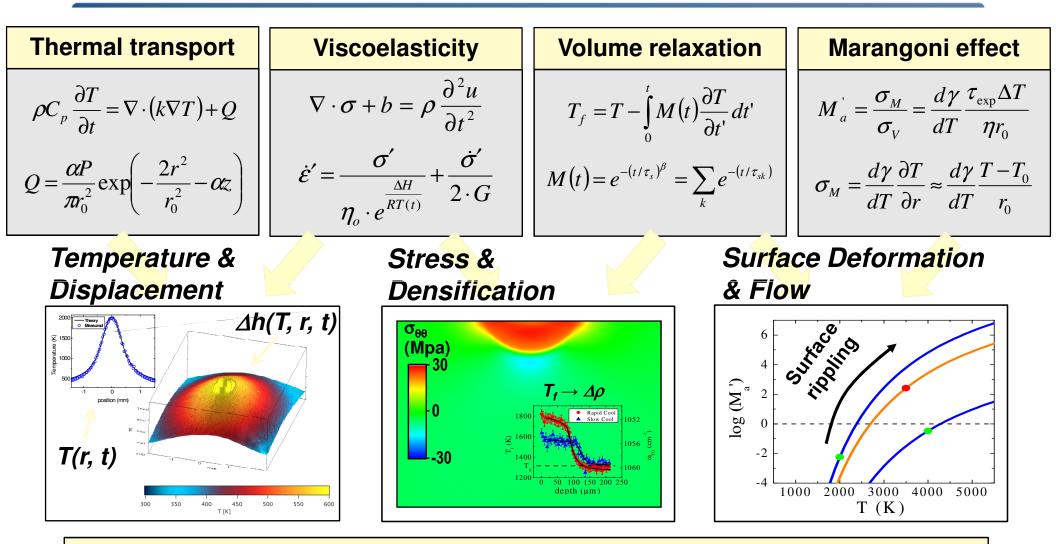
Power spectra from Monte Carlo polishing simulations show good agreement with power spectra of measured polished surfaces



NIF

11/23/12

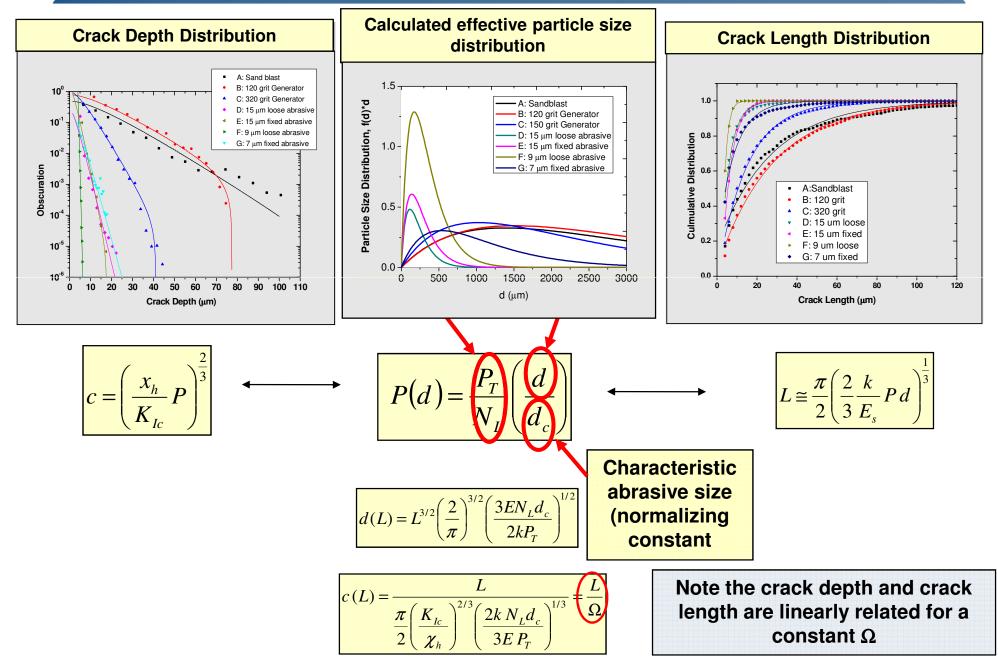
## Coupled thermo-mechanical finite element analysis was used to model laser heating of fused silica (T<2300K)



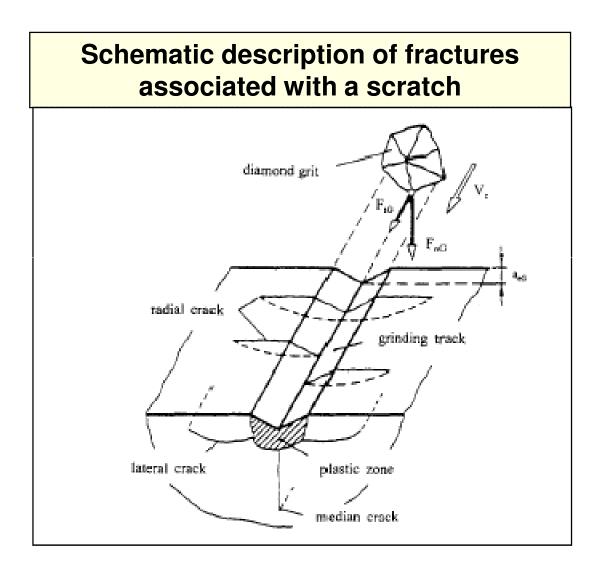
## We have developed predictive physical models for laser-driven material response associated with damage mitigation

R. Vignes, JAC (in press) (2012); S. Yang, J. Appl. Phys. **106**, 1031061 (2009); N. Shen, Appl Surf Sci **256**, 4031(2010); M. Matthews, SPIE 7504 (2009); M. Matthews, Optics Letters **35**, 1-3 (2010)

### Expressions for the crack depth and effective particle size distribution as function of the crack length distribution have been derived



## The effect of load on the fracture behavior of scratches has been measured



• At low loads (P<0.1 N), no cracking is observed just a ductile track

• At intermediate loads (0.1 N< P < 5 N), well defined median and lateral cracks form

 At high loads (P> 5N), the plastically observed track appears to shatter and the median and lateral crack are not as extending as in the higher end of the intermediate loads

## SurF model predicts convergence and convergence rate without any fitting parameters

